

CATHODE (-) END VIEW



SIDE VIEW



ANODE (+) END VIEW



BOTTOM VIEW



Click [here](#) for the 3D model.

Dimensions

| | |
|-----------|-----------------|
| Footprint | 7343 |
| L | 7.3mm +/-0.3mm |
| W | 4.3mm +/-0.3mm |
| H | 2.8mm +/-0.3mm |
| T | 0.13mm REF |
| S | 1.3mm +/-0.3mm |
| F | 2.4mm +/-0.1mm |
| A | 3.8mm MIN |
| B | 0.5mm +/-0.15mm |
| E | 3.5mm REF |
| G | 3.5mm REF |
| P | 0.9mm REF |
| R | 1mm REF |
| X | 0.1mm +/-0.1mm |

Packaging Specifications

Packaging Waffle

General Information

| | |
|------------------|--|
| Series | T540 HRA |
| Dielectric | Polymer Tantalum |
| Style | SMD Chip |
| Description | SMD, Polymer, Molded, High Reliability |
| Features | Non-Combustible, Low ESR, High Reliability |
| RoHS | Yes |
| Termination | Tin |
| AEC-Q200 | No |
| Component Weight | 352.36 mg |
| Shelf Life | 52 Weeks |
| MSL | 3 |

Specifications

| | |
|-------------------------|--|
| Capacitance | 100 uF |
| Capacitance Tolerance | 10% |
| Voltage DC | 16 VDC (105C), 10.72 VDC (125C) |
| Temperature Range | -55/+125°C |
| Rated Temperature | 105°C |
| Humidity | 60C, 90% RH, 500 Hours, rated voltage |
| Dissipation Factor | 10% 120Hz 25C |
| Failure Rate | C (0.01%/1000 Hrs) |
| Resistance | 50 mOhms (100kHz 25C) |
| Ripple Current | 2121 mA (rms, 100kHz 45C) |
| Leakage Current | 160 uA (5min 25°C) |
| Testing and Reliability | 10 Cycles Surge Current Testing At -55C +0C/-5C And +85C +/-5C After Voltage Aging |

单击下面可查看定价，库存，交付和生命周期等信息

[>>KEMET\(基美\)](#)